

-e-Front runners

FUJI POWER MOSFET

Super FAP-E³ series

N-CHANNEL SILICON POWER MOSFET

Features

Maintains both low power loss and low noise Lower R_{DS}(on) characteristic

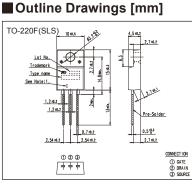
More controllable switching dv/dt by gate resistance Smaller V_{GS} ringing waveform during switching Narrow band of the gate threshold voltage (3.0±0.5V) High avalanche durability

Applications

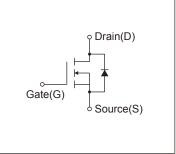
Switching regulators UPS (Uninterruptible Power Supply) **DC-DC** converters

Maximum Ratings and Characteristics

Absolute Maximum Ratings at Tc=25°C (unless otherwise specified)



Equivalent circuit schematic



Description	Symbol	Characteristics	Unit	Remarks
Durin Origina Valdana	VDS	600	V	
Drain-Source Voltage	VDSX	600	V	V _{GS} = -30V
Continuous Drain Current	lo	±5.5	А	
Pulsed Drain Current	IDP	±22	А	
Gate-Source Voltage	Vgs	±30	V	
Repetitive and Non-Repetitive Maximum AvalancheCurrent	lar	5.5	А	Note*1
Non-Repetitive Maximum Avalanche Energy	EAS	262	mJ	Note*2
Repetitive Maximum Avalanche Energy	Ear	3.2	mJ	Note*3
Peak Diode Recovery dV/dt	dV/dt	4.2	kV/µs	Note*4
Peak Diode Recovery -di/dt	-di/dt	100	A/µs	Note*5
Maulaum Damas Dia sin stilan	D	2.16	14/	Ta=25°C
Maximum Power Dissipation	PD	32	W	Tc=25°C
On and the send Oderson Tanana and the senate	Tch	150	°C	
Operating and Storage Temperature range	Tstg	-55 to + 150	°C	
Isolation Voltage	Viso	2	kVrms	t = 60sec, f = 60Hz

• Electrical Characteristics at Tc=25°C (unless otherwise specified)

Description	Symbol	Conditions	Conditions		typ.	max.	Unit
Drain-Source Breakdown Voltage	BVDSS	ID=250µA, VGS=0V		600	-	-	V
Gate Threshold Voltage	Vgs (th)	ID=250µA, VDS=VGS	ID=250µA, VDS=VGS		3.0	3.5	V
Zero Gate Voltage Drain Current		V _{DS} =600V, V _{GS} =0V	Tch=25°C	-	-	25	μA
	IDSS	V _{DS} =480V, V _{GS} =0V	Tch=125°C	-	-	250	
Gate-Source Leakage Current	Igss	V _{GS} =±30V, V _{DS} =0V	V _{GS} =±30V, V _{DS} =0V		10	100	nA
Drain-Source On-State Resistance	RDS (on)	ID=2.8A, VGS=10V		-	1.11	1.30	Ω
Forward Transconductance	g fs	ID=2.8A, VDS=25V		3	6	-	S
Input Capacitance	Ciss	V _{DS} =25V V _{GS} =0V f=1MHz		-	1020	1530	pF
Output Capacitance	Coss			-	95	143	
Reverse Transfer Capacitance	Crss			-	7	10.5	
Turn-On Time	td(on)	V _{cc} =300V V _{cs} =10V I _b =2.8A R _s =24Ω		-	11	16.5	ns
	tr			-	8.5	13	
Turn-Off Time	td(off)			-	80	120	
	tf			-	17	25.5	
Total Gate Charge	QG	V _{cc} =300V I _D =5.5A V _{cs} =10V		-	33	50	nC
Gate-Source Charge	QGS			-	8.5	13	
Gate-Drain Charge	QGD			-	9.5	14.5	
Avalanche Capability	lav	L=6.35mH, Tch=25°C		5.5	-	-	А
Diode Forward On-Voltage	Vsd	IF=5.5A, VGS=0V, Tch=25°C		-	0.86	1.30	V
Reverse Recovery Time	trr	IF=5.5A, VGS=0V		-	0.4	-	μS
Reverse Recovery Charge	Qrr	-di/dt=100A/µs, Tch=25°C		-	3.0	-	μC

Thermal Characteristics

Description	Symbol	Test Conditions	min.	typ.	max.	Unit
Thermal resistance	Rth (ch-c)	Channel to Case			3.910	°C/W
	Rth (ch-a)	Channel to Ambient			58.0	°C/W

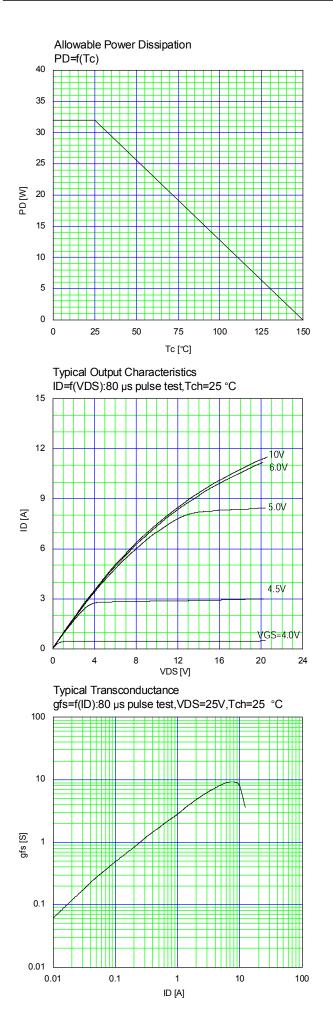
Note *1 : Tch≤150°C

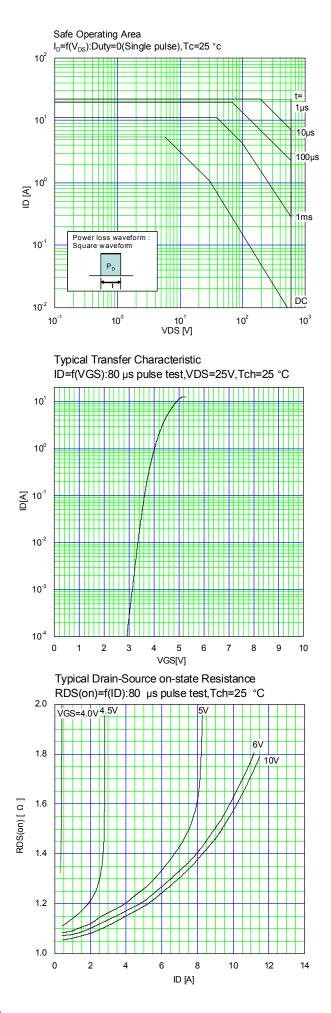
Note 1 : Italia 50 °C, IAs=2 2A, L=99.2mH, Vcc=60V, R_G=50Ω EAs limited by maximum channel temperature and avalanche current. See to 'Avalanche Energy' graph.

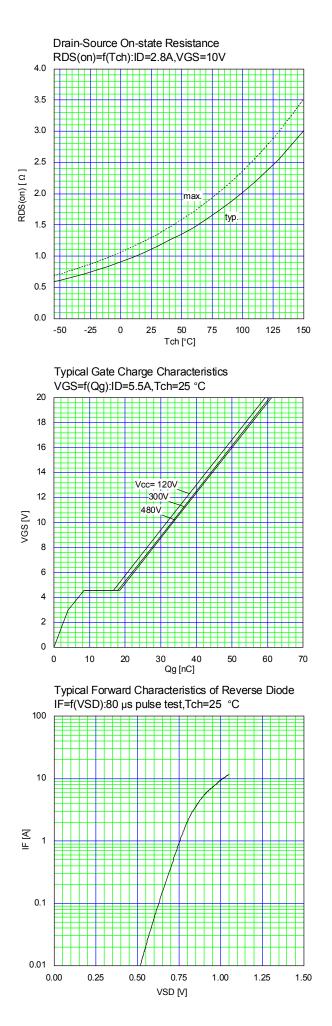
Note *3 : Repetitive rating : Pulse width limited by maximum channel temperature

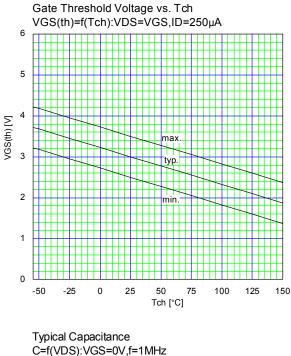
See to the 'Transient Themal impeadance' graph. Note *4 $\,:$ IFS-ID, -di/dt=100A/µs, VccSBVDss, TchS150°C.

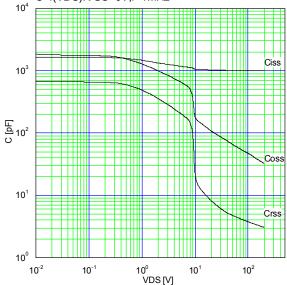
Note *5 : IF≤-ID, dv/dt=4.2kV/µs, Vcc≤BVDss, Tch≤150°C.



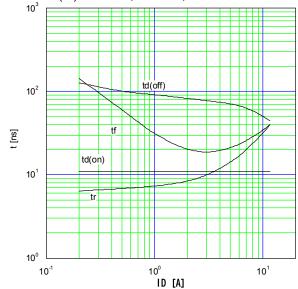


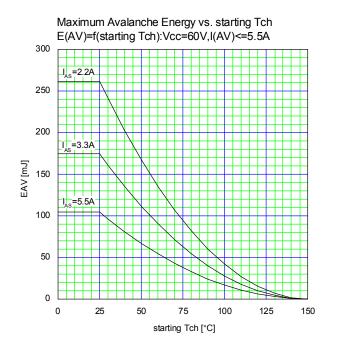


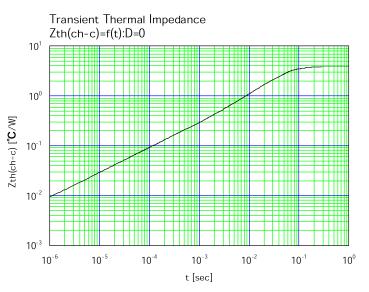




Typical Switching Characteristics vs. ID t=f(ID):Vcc=300V,VGS=10V,RG=24 $\ \Omega$







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